

EPO-TEK® 320

Technical Data Sheet For Reference Only *Optical, Opaque Epoxy*

Date: September 2017

Rev: III
No. of Components: Two
Mix Ratio by Weight: 10:2

Specific Gravity: Part A: 1.10 Part B: 0.87

Pot Life: 1 Hour

Shelf Life- Bulk: One year at room temperature

Recommended Cure: 65°C / 2 Hours

Minimum Alternative Cure(s):

May not achieve performance properties listed below

23°C / 24 Hours

NOTES:

• Container(s) should be kept closed when not in use.

• Filled systems should be stirred thoroughly before mixing and prior to use.

- Performance properties (rheology, conductivity, others) of the product may vary from those stated on the data sheet when bi-pak/syringe packaging or post-processing of any kind is performed. Epoxy's warranties shall not apply to any products that have been reprocessed or repackaged from Epoxy's delivered status/container into any other containers of any kind, including but not limited to syringes, bi-paks, cartridges, pouches, tubes, capsules, films or other packages.
- Syringe packaging will impact initial viscosity and effective pot life, potentially beyond stated parameters.
- TOTAL MASS SHOULD NOT EXCEED 25 GRAMS

<u>Product Description:</u> EPO-TEK® 320 is a two component, black-colored and optically opaque epoxy designed for optical, medical, and opto-electronic packaging of semiconductor devices and components. It is a widely used fiber-optic grade epoxy.

<u>Typical Properties:</u> Cure condition: Varies as required Different batches, conditions & applications yield differing results.

Data below is not guaranteed. To be used as a guide only, not as a specification. * denotes test on lot acceptance basis

DUVOIGAL PROPERTIES.		
PHYSICAL PROPERTIES:		
* Color (before cure):	Part A: Black	Part B: Clear/Colorless
* Consistency:	Slightly thixotropic paste	
* Viscosity (23°C) @ 100 rpm:	700 - 1,200	cPs
Thixotropic Index:	5.7	
* Glass Transition Temp:	≥ 55	°C (Dynamic Cure: 20-200°C/ISO 25 Min; Ramp -10-200°C @20°C/Min)
Coefficient of Thermal Expansion (CTE):		
Below Tg:	29	x 10 ⁻⁶ in/in°C
Above Tg:	100	x 10 ⁻⁶ in/in°C
Shore D Hardness:	83	
Lap Shear @ 23°C:	> 2,000	psi
Die Shear @ 23°C:	≥ 15	Kg 5,334 psi
Degradation Temp:	384	°C
Weight Loss:		
@ 200°C:	0.27	%
@ 250°C:	0.45	%
@ 300°C:	0.80	%
Suggested Operating Temperature:	< 300	°C (Intermittent)
Storage Modulus:	261,271	psi
* Particle Size:	≤ 20	microns

ELECTRICAL AND THERMAL PROPERTIES:			
Thermal Conductivity:	N/A		
Volume Resistivity @ 23°C:	≥ 1 x 10 ⁶	Ohm-cm	
Dielectric Constant (1KHz):	N/A		
Dissipation Factor (1KHz):	N/A		

OPTICAL PROPERTIES @ 23°C:		
Spectral Transmission:	< 1 % @ 300-2500	nm
Refractive Index:	N/A	



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EPO-TEK® 320 Advantages & Suggested Application Notes:

- Optically opaque between IR and VISIBLE regions of light, including 185 2500 nm range
- It can be used for room temperature curing, low temp, or box oven elevated temperature cure.
- Many modifications are available, such as viscosity, electrical insulation, Tg, and flexibility. Contact <u>techserv@epotek.com</u> for your best recommendation.
- Suggested Applications:
 - o Optical:
 - blocking light in photonics packaging through VIS and NIR range; sensor packaging including IR detectors packaged in TO-cans
 - bonding of various optics including lens, prism, diodes
 - adhesion to metals, most plastics, and glasses
 - Fiber optics: sealing / potting fibers into the boot, ferrule, or fiber feed-through of the package wall
- The low viscosity nature allows syringe dispensing and automation, hand, brushing, roller coating, tooth-pick or spatula, and pour or dipping